

Amendments to the Abstract

Kindly replace the original abstract (page 27) with the following substitute abstract.

ABSTRACT

A component mounting method including carrying in a circuit board to a component mounting position and carrying out the circuit board after a component-mounting operation. The component mounting operation includes sucking up the component from the component feed section and moving the component to the mounting position, and mounting the component on a specified site of the circuit board. Also, a remaining-component discarding operation is performed to discard a component which remains at the suction nozzle during a specified time period following the component-mounting operation while the component mounting operation is stopped.